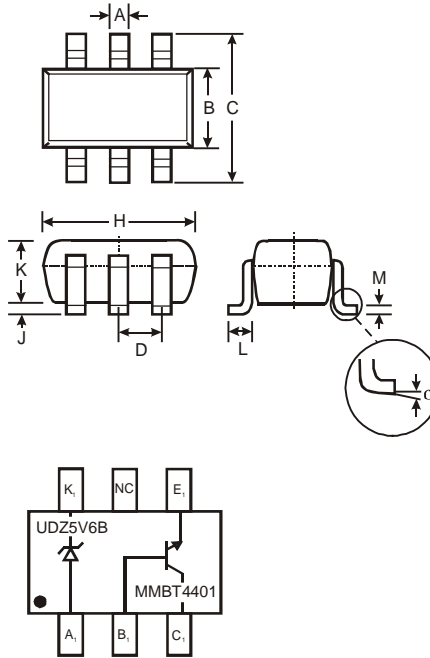


## Features

- Epitaxial Planar Die Construction
- Ideally Suited for Automated Assembly Processes
- Available in Lead Free/RoHS Compliant Version (Note 2)

## Mechanical Data

- Case: SOT-26
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminal Connections: See Diagram
- Terminals: Solderable per MIL-STD-202, Method 208
- Also Available in Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe). Please see Ordering Information, Note 5, on Page 4
- Marking: AH1
- Marking & Type Code Information: See Page 4
- Ordering Information: See Page 4
- Weight: 0.008 grams (approximate)



SOT-26			
Dim	Min	Max	Typ
A	0.35	0.50	0.38
B	1.50	1.70	1.60
C	2.70	3.00	2.80
D	—	—	0.95
H	2.90	3.10	3.00
J	0.013	0.10	0.05
K	1.00	1.30	1.10
L	0.35	0.55	0.40
M	0.10	0.20	0.15
$\alpha$	0°	8°	—

All Dimensions in mm

## Maximum Ratings, NPN Transistor Element

@T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CB0</sub>	60	V
Collector-Emitter Voltage	V <sub>CEO</sub>	40	V
Emitter-Base Voltage	V <sub>EBO</sub>	6.0	V
Collector Current - Continuous (Note 1)	I <sub>C</sub>	600	mA

## Maximum Ratings, Zener Element

@T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Forward Voltage @ I <sub>F</sub> = 10mA	V <sub>F</sub>	0.9	V

## Thermal Characteristics

@T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 1)	P <sub>D</sub>	300	mW
Thermal Resistance, Junction to Ambient (Note 1)	R <sub>θJA</sub>	417	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

- Notes:
1. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.
  2. No purposefully added lead.

**Electrical Characteristics, NPN Transistor Element** @ $T_A = 25^\circ\text{C}$  unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
<b>OFF CHARACTERISTICS (Note 3)</b>					
Collector-Base Breakdown Voltage	$V_{(BR)CBO}$	60	—	V	$I_C = 100\mu\text{A}, I_E = 0$
Collector-Emitter Breakdown Voltage	$V_{(BR)CEO}$	40	—	V	$I_C = 1.0\text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage	$V_{(BR)EBO}$	6.0	—	V	$I_E = 100\mu\text{A}, I_C = 0$
Collector Cutoff Current	$I_{CEX}$	—	100	nA	$V_{CE} = 35\text{V}, V_{EB(OFF)} = 0.4\text{V}$
Base Cutoff Current	$I_{BL}$	—	100	nA	$V_{CE} = 35\text{V}, V_{EB(OFF)} = 0.4\text{V}$
<b>ON CHARACTERISTICS (Note 3)</b>					
DC Current Gain	$h_{FE}$	20	—	—	$I_C = 100\mu\text{A}, V_{CE} = 1.0\text{V}$
		40	—		$I_C = 1.0\text{mA}, V_{CE} = 1.0\text{V}$
		80	—		$I_C = 10\text{mA}, V_{CE} = 1.0\text{V}$
		100	300		$I_C = 150\text{mA}, V_{CE} = 1.0\text{V}$
		40	—		$I_C = 500\text{mA}, V_{CE} = 2.0\text{V}$
Collector-Emitter Saturation Voltage	$V_{CE(SAT)}$	—	0.40 0.75	V	$I_C = 150\text{mA}, I_B = 15\text{mA}$ $I_C = 500\text{mA}, I_B = 50\text{mA}$
Base-Emitter Saturation Voltage	$V_{BE(SAT)}$	0.75	0.95 1.2	V	$I_C = 150\text{mA}, I_B = 15\text{mA}$ $I_C = 500\text{mA}, I_B = 50\text{mA}$
<b>SMALL SIGNAL CHARACTERISTICS</b>					
Output Capacitance	$C_{cb}$	—	6.5	pF	$V_{CB} = 5.0\text{V}, f = 1.0\text{MHz}, I_E = 0$
Input Capacitance	$C_{eb}$	—	30	pF	$V_{EB} = 0.5\text{V}, f = 1.0\text{MHz}, I_C = 0$
Input Impedance	$h_{ie}$	1.0	15	k $\Omega$	$V_{CE} = 10\text{V}, I_C = 1.0\text{mA}, f = 1.0\text{kHz}$
Voltage Feedback Ratio	$h_{re}$	0.1	8.0	$\times 10^{-4}$	
Small Signal Current Gain	$h_{fe}$	40	500	—	
Output Admittance	$h_{oe}$	1.0	30	$\mu\text{S}$	
Current Gain-Bandwidth Product	$f_T$	250	—	MHz	
<b>SWITCHING CHARACTERISTICS</b>					
Delay Time	$t_d$	—	15	ns	$V_{CC} = 30\text{V}, I_C = 150\text{mA}, V_{BE(off)} = 2.0\text{V}, I_{B1} = 15\text{mA}$
Rise Time	$t_r$	—	20	ns	
Storage Time	$t_s$	—	225	ns	$V_{CC} = 30\text{V}, I_C = 150\text{mA}, I_{B1} = I_{B2} = 15\text{mA}$
Fall Time	$t_f$	—	30	ns	

**Electrical Characteristics, Zener Element** @ $T_A = 25^\circ\text{C}$  unless otherwise specified

Type Number	Zener Voltage Range (Note 3)				Maximum Zener Impedance		Maximum Reverse Leakage Current	
	$V_Z @ I_{ZT}$			$I_{ZT}$ mA	$Z_{ZT} @ I_{ZT}$	$Z_{ZK} @ I_{ZK} = 0.5\text{mA}$	$I_R$ $\mu\text{A}$	@ $V_R$ V
	Nom (V)	Min (V)	Max (V)					
UDZ5V6B	5.6	5.49	5.73	5	60	200	1.0	2.5

Notes: 3. Short duration pulse test used to minimize self-heating effect.

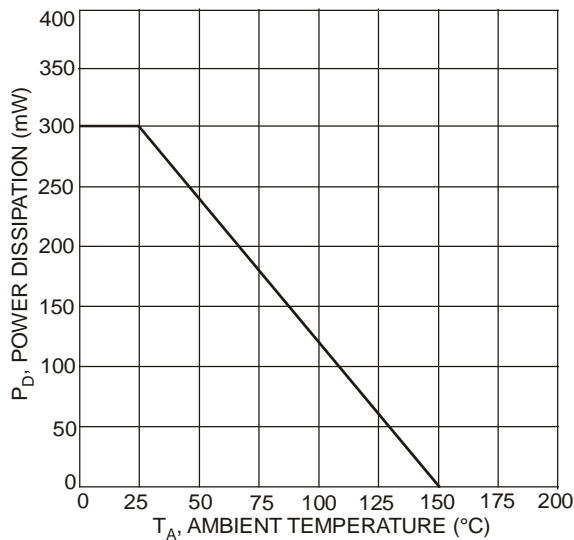
**NPN Transistor Section**


Fig. 1 Max Power Dissipation vs. Ambient Temperature (Total Device)

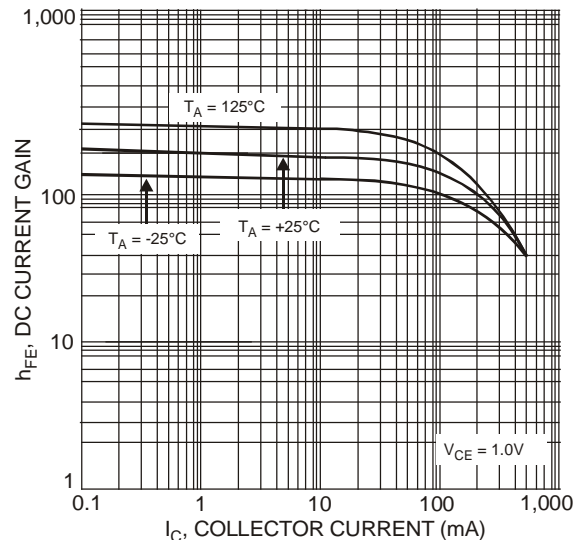


Fig. 2 Typical DC Current Gain vs. Collector Current

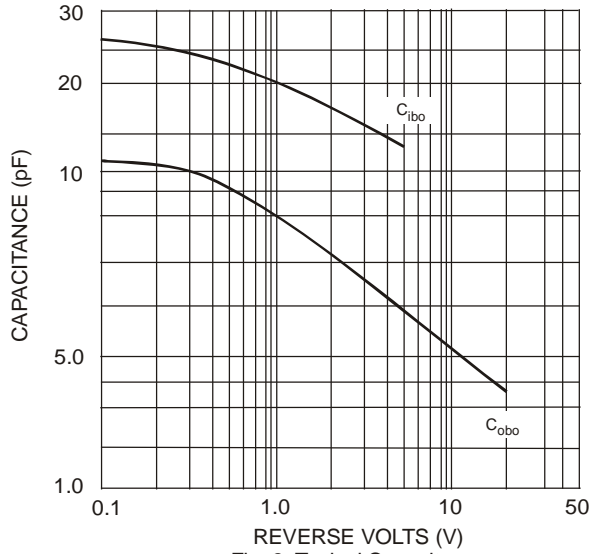


Fig. 3 Typical Capacitance

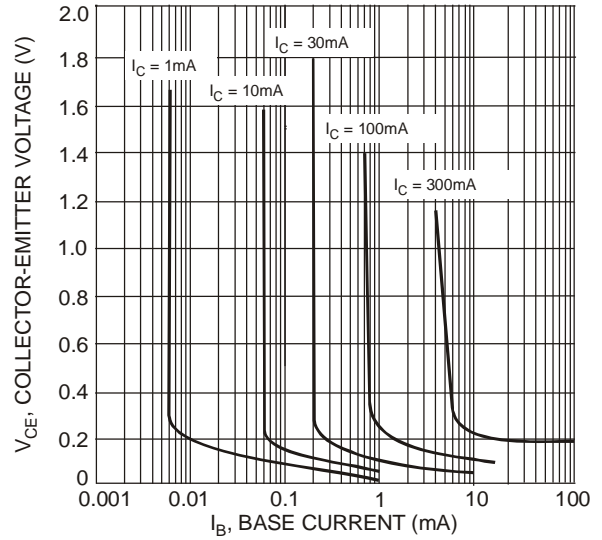


Fig. 4 Typical Collector Saturation Region

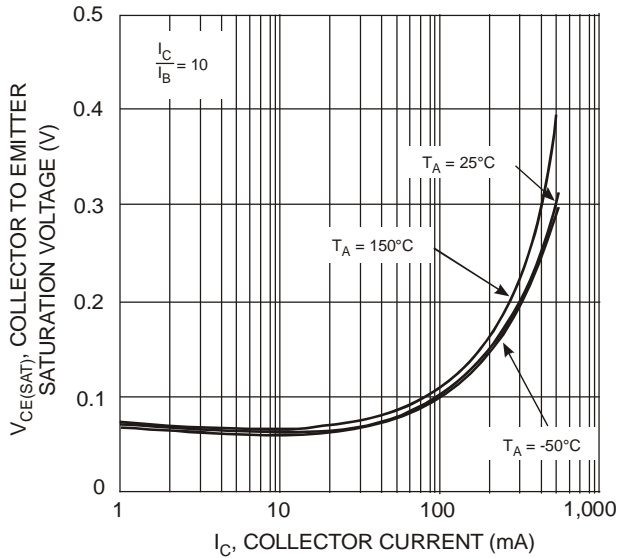


Fig. 5 Collector Saturation Voltage vs. Collector Current

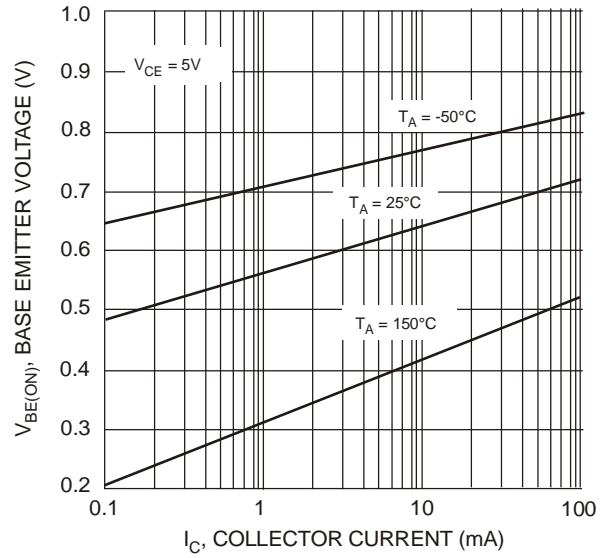


Fig. 6 Base Emitter Voltage vs. Collector Current

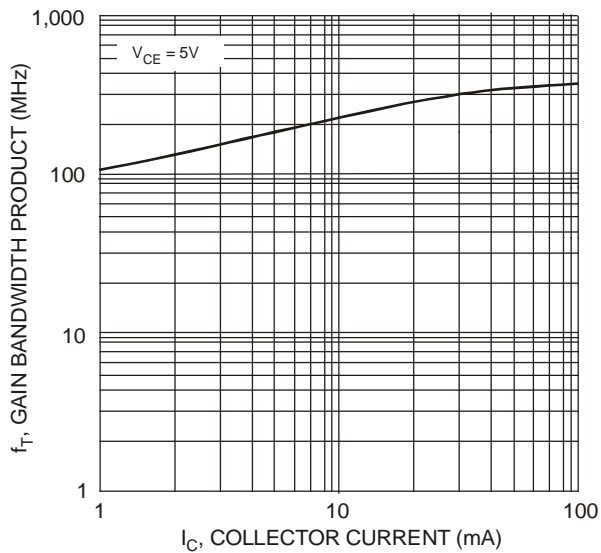


Fig. 7 Gain Bandwidth Product vs. Collector Current

## Zener Section

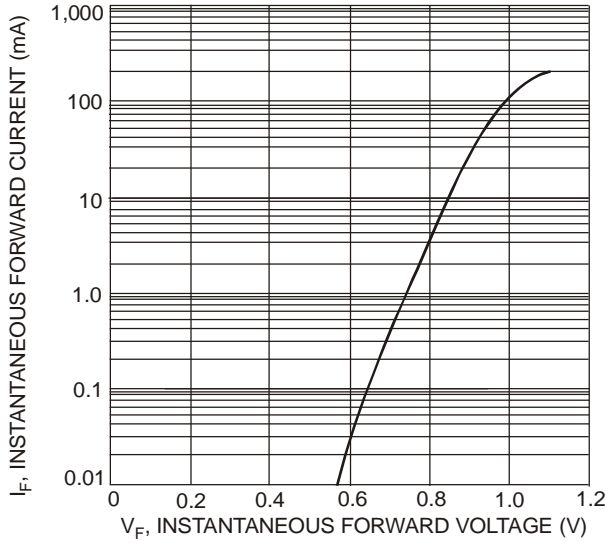


Fig. 8 Typical Forward Characteristics

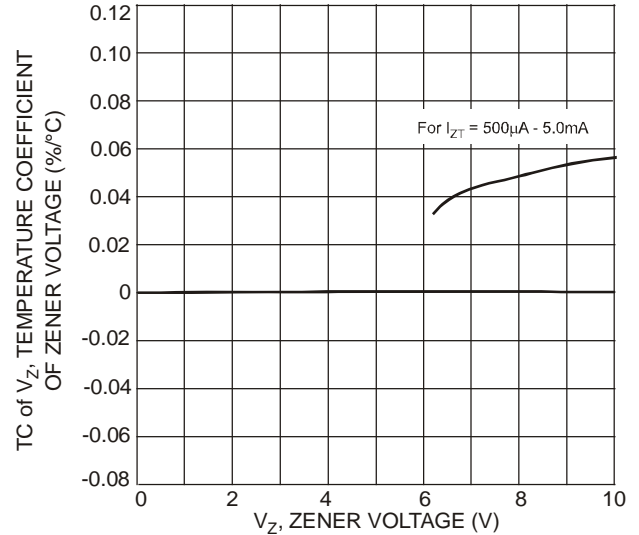


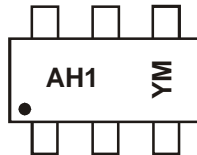
Fig. 9 Typical Temperature Coefficient of Zener Voltage vs. Zener Voltage, UDZ5V6B

### Ordering Information (Notes 4 and 5)

Device	Packaging	Shipping
DVRN6056-7	SOT-26	3000/Tape & Reel

- Notes:
- For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.
  - For Lead Free/RoHS Compliant version part number, please add "-F" suffix to the part number above. Example: DVRN6056-7-F.

### Marking Information



AH1 = Product Type Marking Code  
 YM = Date Code Marking  
 Y = Year (ex: P = 2003)  
 M = Month (ex: 9 = September)

#### Date Code Key

Year	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	P	R	S	T	U	V	W	X	Y	Z

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

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